

2.8X1.0mm RIGHT ANGLE SMD CHIP **LED LAMP**

PRELIMINARY SPEC



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: APKA2810VGC/A-F01 Green

Features

- 2.8mmX1.0mm RIGHT ANGLE SMT LED, 1.2mm THICKNESS.
- LOW POWER CONSUMPTION.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

Description

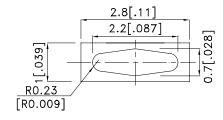
The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.

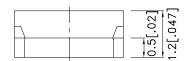
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

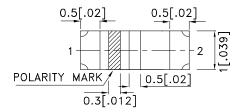
Package Dimensions

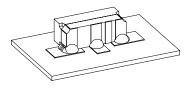












- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(\pm 0.01")$ unless otherwise noted.
- Specifications are subject to change without notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAG5759 **REV NO: V.2** DATE: MAY/08/2007 PAGE: 1 OF 5 APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.L.LI ERP: 1204000840

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APKA2810VGC/A-F01	Green (InGaN)	WATER CLEAR	70	200	90°

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	520		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	35		nm	IF=20mA
С	Capacitance	Green	100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.2	4	V	IF=20mA
lR	Reverse Current	Green		10	uA	V _R =5V

1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

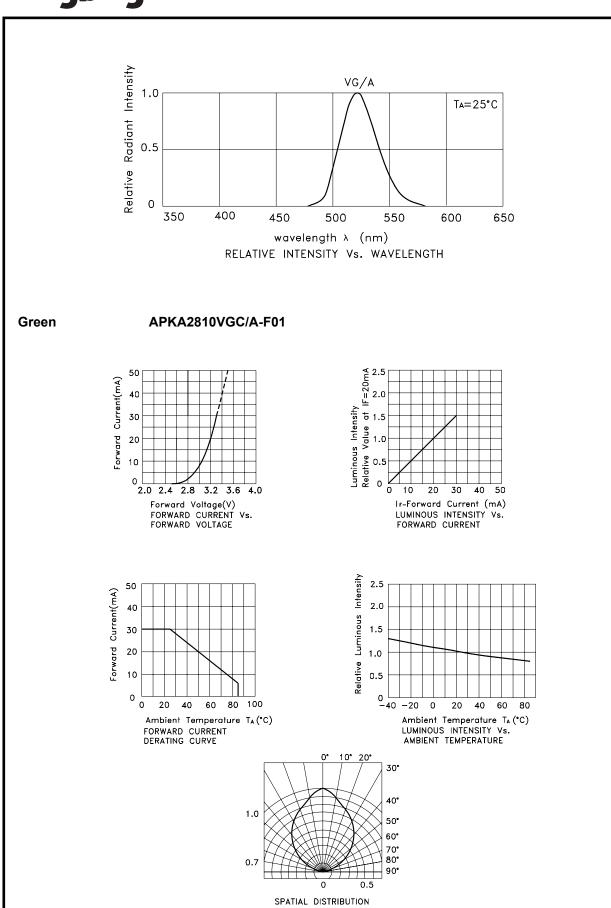
Absolute Maximum Ratings at TA=25°C

Parameter	Green		
Power dissipation	120	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	100	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAG5759 **REV NO: V.2** DATE: MAY/08/2007 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.L.LI ERP: 1204000840

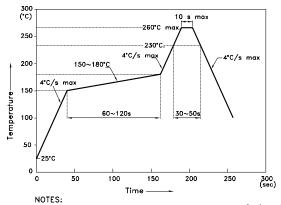


 SPEC NO: DSAG5759
 REV NO: V.2
 DATE: MAY/08/2007
 PAGE: 3 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Y.L.LI
 ERP: 1204000840

APKA2810VGC/A-F01

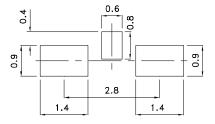
Reflow Soldering Profile For Lead-free SMT Process.



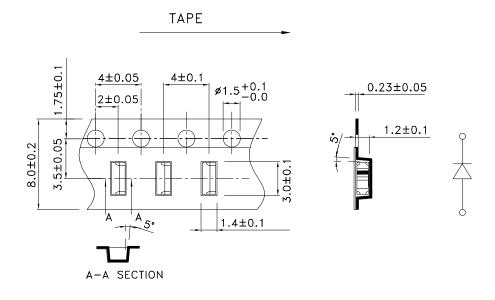
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Specifications (Units: mm)



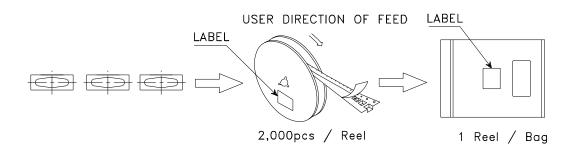
SPEC NO: DSAG5759 APPROVED: WYNEC

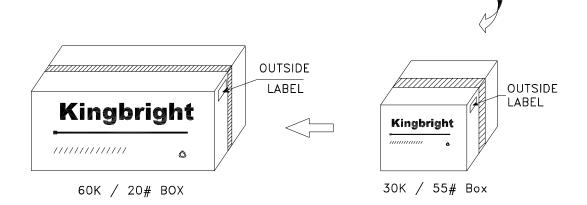
REV NO: V.2 CHECKED: Allen Liu DATE: MAY/08/2007 DRAWN: Y.L.LI

PAGE: 4 OF 5 ERP: 1204000840

PACKING & LABEL SPECIFICATIONS

APKA2810VGC/A-F01







SPEC NO: DSAG5759 APPROVED: WYNEC

REV NO: V.2 CHECKED: Allen Liu **DATE: MAY/08/2007** DRAWN: Y.L.LI

PAGE: 5 OF 5 ERP: 1204000840